

PLASTIC LEADED CHIP CARRIER SOCKET SURFACE MOUNT

PLCC SERIES

INTRODUCTION:

Adam Tech SMT PLCC Series Sockets are low profile, thin wall sockets designed to convert plastic leaded chips to a thru-hole PCB format on a .100" centerline grid. They conform to JEDEC MS 016 and MS 018 pin count standards. Adam Tech's superior precision stamped contact design provides consistent, high retention contacts for all size chips. Chip exchanges or replacements are easily made with Adam Tech's chip remover part no. PLCC-EXT.

FEATURES:

Full range of sizes from 20P ~ 100P Consistent, uniform high retention contacts Compatible with wide range of chip sizes No solder wicking design Hi Temp PPS insulator Open frame design for viewable solder joints

MATING PLASTIC LEADED CHIPS:

All EIA / JEDEC compliant PLCC

SPECIFICATIONS:

Material:

Standard Hi-Temp insulator: PPS, Glass reinforced, rated UL94V-0

Insulator Color: Brown Contacts: Phosphor Bronze

Contact Plating:

Tin over copper underplate overall

Electrical:

Operating voltage: 250V AC max. Current rating: 1 Amp max.

Contact resistance: 30 mΩ max. initial Insulation resistance: 1000 M Ω min.

Dielectric withstanding voltage: 500V AC for 1 minute

Mechanical:

Insertion force: 6.35 oz max. Withdrawal force: 1.0 oz min

Temperature Rating:

Operating temperature: -55°C to +105°C Soldering process temperature: 260°C

PACKAGING:

Anti-ESD plastic tubes

APPROVALS AND CERTIFICATIONS:

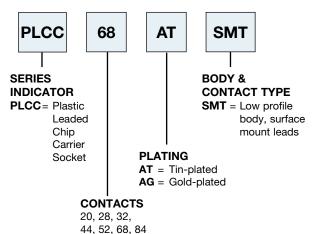
UL Recognized & CSA Certified, File no. E224053







ORDERING INFORMATION



OPTIONS:

Add designator(s) to end of part number

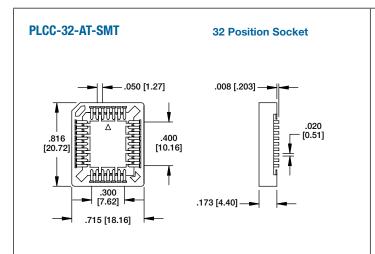
P = With polarizing pegs

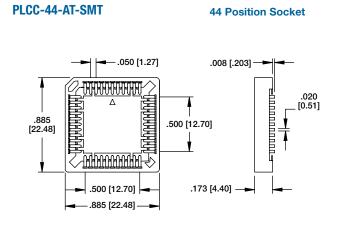
TR = Tape and reel packaging



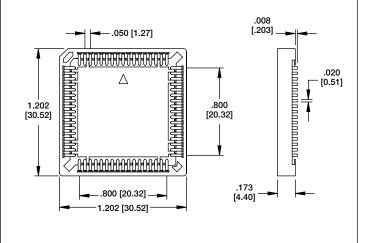
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PLCC SERIES

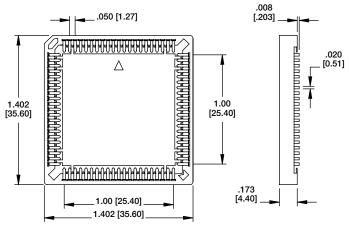




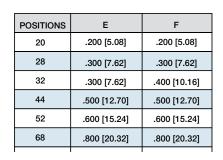
PLCC-68-AT-SMT 68 Position Socket

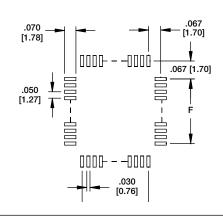






Recommended Solder Pad Layout







PLASTIC LEADED CHIP CARRIER SOCKET
THRU-HOLE
PLCC SERIES

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FEATURES:

Full range of sizes from 20P ~ 100P Consistent, uniform high retention contacts Compatible with wide range of chip sizes No solder wicking design Hi Temp PPS insulator version available

MATING PLASTIC LEADED CHIPS:

All EIA / JEDEC plastic leaded chips

SPECIFICATIONS:

Material:

Standard Insulator: PBT, Glass reinforced, rated UL94V-0

Optional Hi-Temp insulator: PPS Insulator Color: Black (Brown for PPS) Contacts: Phosphor Bronze

Contact Plating:

Tin over copper underplate overall

Electrical:

Operating voltage: 250V AC max. Current rating: 1 Amp max.

Contact resistance: 30 m Ω max. initial Insulation resistance: 1000 M Ω min.

Dielectric withstanding voltage: 500V AC for 1 minute

Mechanical:

Insertion force: 6.35 oz max. Withdrawal force: 1.0 oz min

Temperature Rating:

Operating temperature: -20°C to +85°C Soldering process temperature:

Standard insulator: 235°C Hi-Temp insulator: 260°C

PACKAGING:

Anti-ESD plastic tubes

APPROVALS AND CERTIFICATIONS:

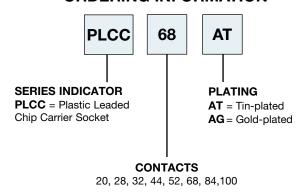
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OPTIONS:

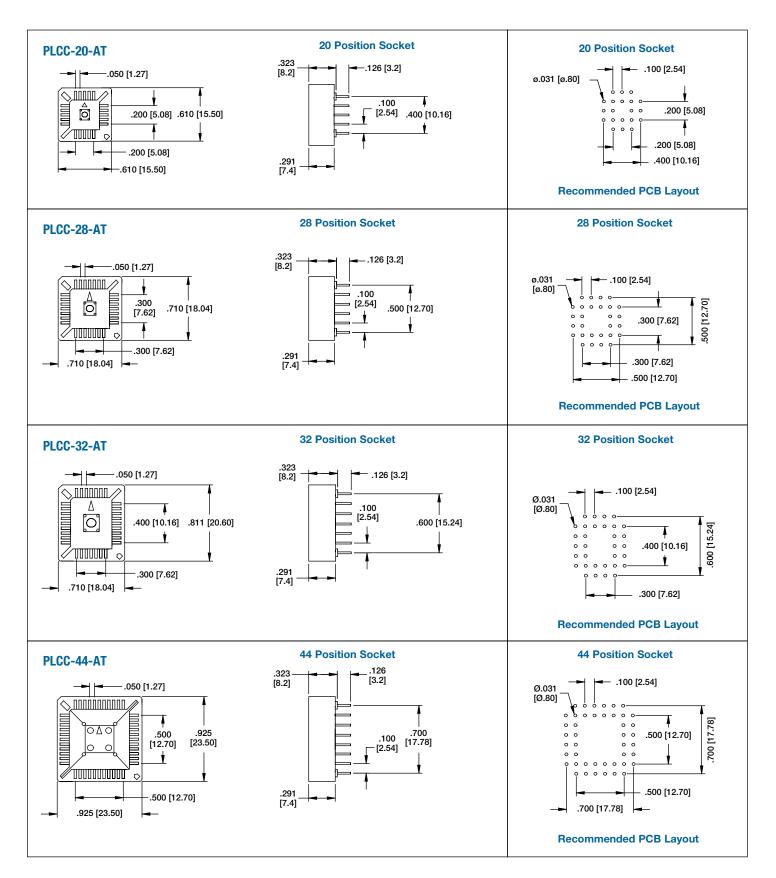
Add designator(s) to end of part number

HT = Hi-Temp Polyphenylene Sulfide (PPS) Insulator Material for hi-temp soldering process up to 260°C

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PLASTIC LEADED CHIP CARRIER SOCKET THROUGH HOLE PLCC SERIES





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